

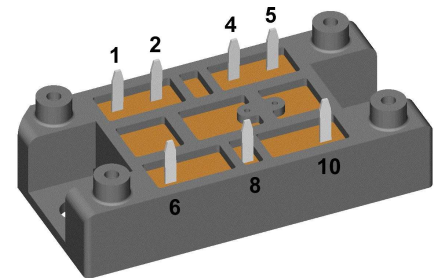
Standard Rectifier Module

3~ Rectifier	
V_{RRM}	= 1800 V
I_{DAV}	= 45 A
I_{FSM}	= 300 A

3~ Rectifier Bridge

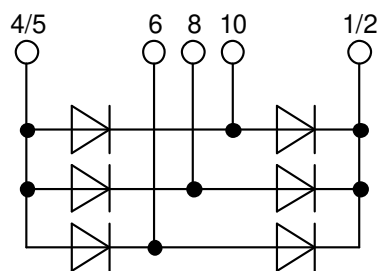
Part number

VUO34-18NO1



Backside: isolated

 E72873



Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

Applications:

- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: V1-A-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

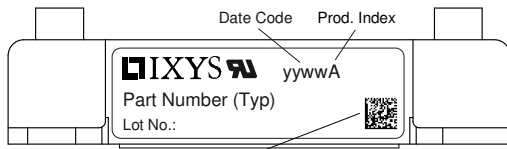
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Rectifier				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}C$		1900	V
V_{RRM}	max. repetitive reverse blocking voltage			$T_{VJ} = 25^{\circ}C$		1800	V
I_R	reverse current	$V_R = 1800 V$		$T_{VJ} = 25^{\circ}C$		20	μA
		$V_R = 1800 V$		$T_{VJ} = 150^{\circ}C$		1	mA
V_F	forward voltage drop	$I_F = 15 A$		$T_{VJ} = 25^{\circ}C$		1.13	V
		$I_F = 45 A$				1.46	V
		$I_F = 15 A$		$T_{VJ} = 125^{\circ}C$		1.06	V
		$I_F = 45 A$				1.48	V
I_{DAV}	bridge output current	$T_C = 110^{\circ}C$		$T_{VJ} = 150^{\circ}C$		45	A
		rectangular	$d = \frac{1}{3}$				
V_{FO}	threshold voltage	} for power loss calculation only		$T_{VJ} = 150^{\circ}C$		0.81	V
r_F	slope resistance					14.9	m Ω
R_{thJC}	thermal resistance junction to case					1.7	K/W
R_{thCH}	thermal resistance case to heatsink				0.4		K/W
P_{tot}	total power dissipation			$T_C = 25^{\circ}C$		70	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}C$		300	A
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{ sine}$		$V_R = 0 V$		325	A
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}C$		255	A
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{ sine}$		$V_R = 0 V$		275	A
I^2t	value for fusing	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{ sine}$		$T_{VJ} = 45^{\circ}C$		450	A ² s
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{ sine}$		$V_R = 0 V$		440	A ² s
		$t = 10 \text{ ms}; (50 \text{ Hz}), \text{ sine}$		$T_{VJ} = 150^{\circ}C$		325	A ² s
		$t = 8,3 \text{ ms}; (60 \text{ Hz}), \text{ sine}$		$V_R = 0 V$		315	A ² s
C_J	junction capacitance	$V_R = 400 V; f = 1 \text{ MHz}$		$T_{VJ} = 25^{\circ}C$		11	pF



Package V1-A-Pack		Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{VJ}	virtual junction temperature		-40		150	°C
T_{op}	operation temperature		-40		125	°C
T_{stg}	storage temperature		-40		125	°C
Weight				37		g
M_D	mounting torque		2		2.5	Nm
$d_{Spp/App}$	creepage distance on surface / striking distance through air	terminal to terminal	6.0			mm
$d_{Spb/Apb}$		terminal to backside	12.0			mm
V_{ISOL}	isolation voltage	t = 1 second	3600			V
		t = 1 minute	3000			V



Data Matrix: Typ (1-19), DC+Prod.Index (20-25), FKT# (26-31)
leer (33), lld.# (33-36)

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUO34-18NO1	VUO34-18NO1	Blister	24	515814

Equivalent Circuits for Simulation

* on die level

$T_{VJ} = 150^{\circ}C$



$V_{0\ max}$	threshold voltage	0.81	V
$R_{0\ max}$	slope resistance *	13.7	mΩ

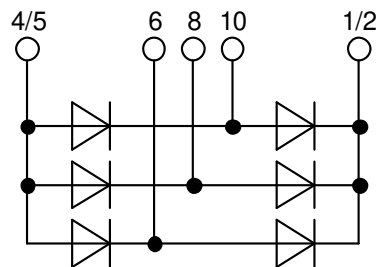


Outlines V1-A-Pack



Remarks / Bemerkungen:

1. Nominal distance mounting screws on heat sink: 52 mm / Nennabstand Befestigungsschrauben auf Kühlkörper: 52 mm
2. General tolerance / Allgemeintoleranz: DIN ISO 2768 -T1-c
3. Surface treatment of pins: tin plated (Sn) in hot dip / Oberflächenbehandlung der Pins: verzinkt (Sn) im Tauchbad
4. Detail X: EJOPT® self-tapping screws (dimension K25) to be recommended for mounting on PCB
selbstschneidende Schraube (Größe K25) empfohlen für die PCB-Montage
Take care on the maximum screw length according to board thickness and the maximum hole depth of 6 mm^L
Bei der Wahl der Schraubenlänge die PCB-Dicke und die maximale Lochtiefe von 6mm beachten
Recommended mounting torque: 1.5 Nm / Empfohlenes Drehmoment: 1.5 Nm



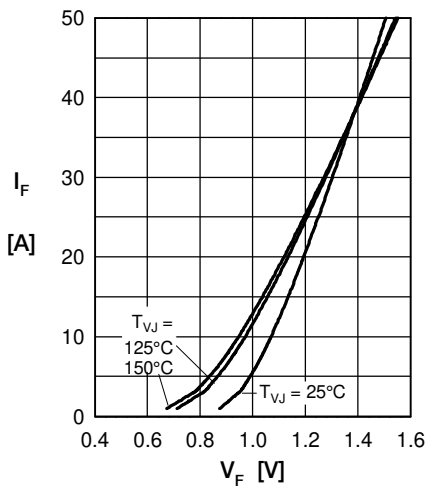
Rectifier


Fig. 1 Forward current vs. voltage drop per diode

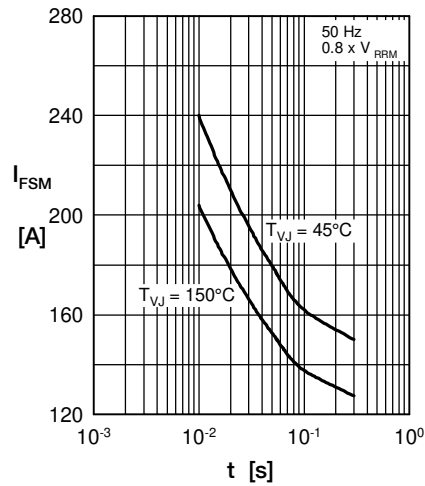


Fig. 2 Surge overload current vs. time per diode

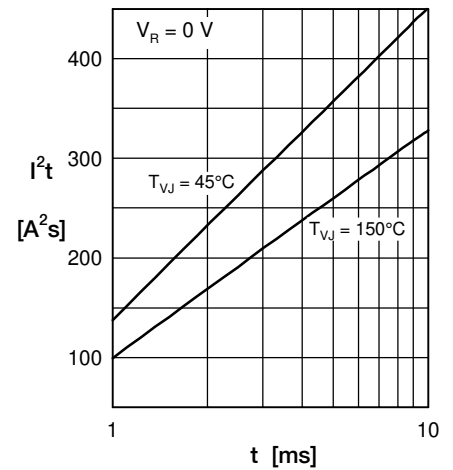
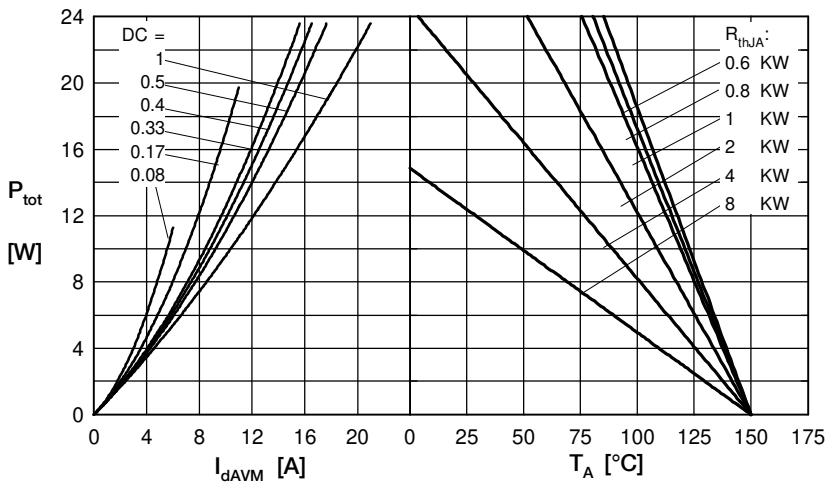

 Fig. 3 I^2t vs. time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

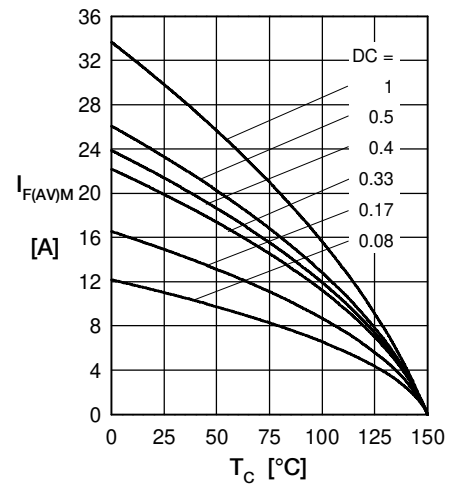


Fig. 5 Max. forward current vs. case temperature per diode

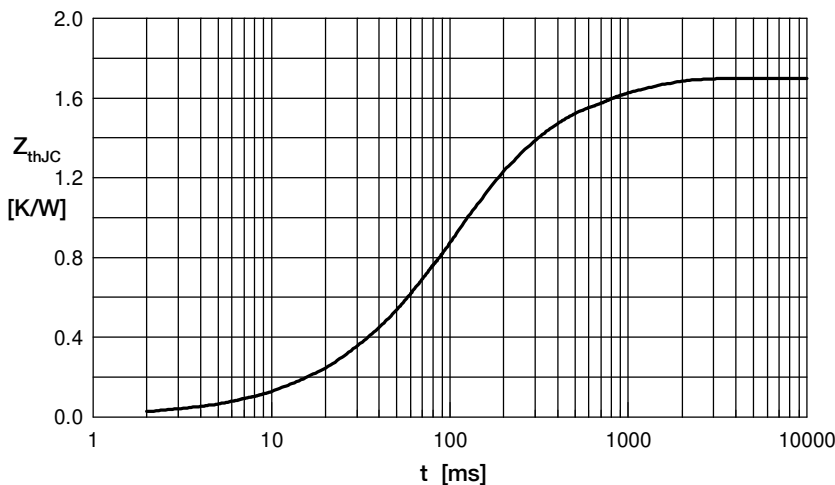


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for Z_{thJC} calculation:

i	R_{th} (K/W)	t_i (s)
1	1.150	0.1015
2	0.150	0.1026
3	0.100	0.4919
4	0.300	0.6200